

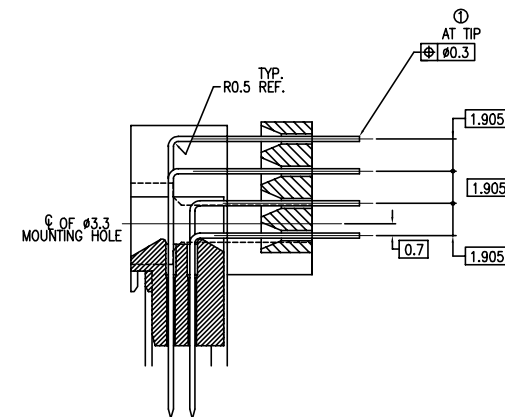
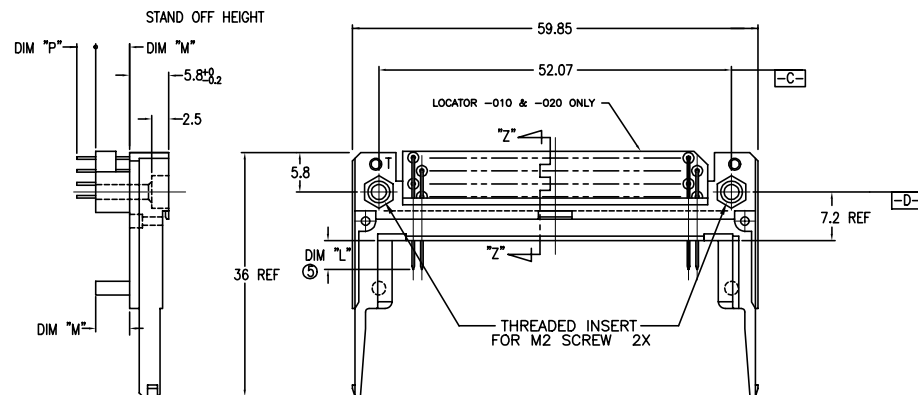
BOTTOM MOUNT
 95706-5XX

 PCB
 NATURAL(WHITE)COLOR

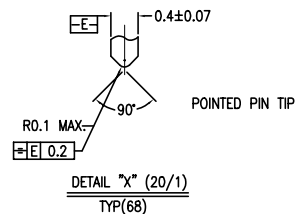
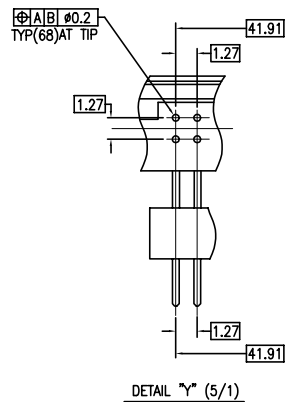
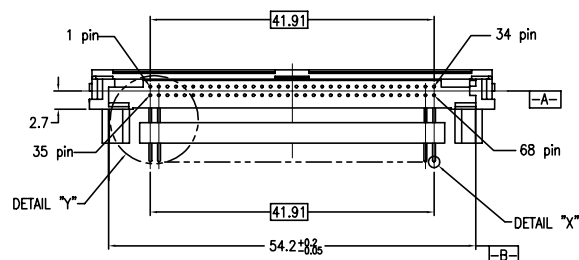
0 : 0mm
1 : 4mm
2 : 5mm
4 : 2mm
0 : TOP MOUNTING
5 : BOTTOM MOUNTING



PRODUCT NO.
95706-010/010LF
95706-020/020LF
95706-040/040LF



SECTION "Z"- "Z" (5/1)



NOTES

- ① TRUE POSITION IS A FREE GRID TO PIN PATTERN ITSELF.
- ② SEE TA-946 FOR PCB LAYOUT.
- ③ MATERIAL
HOUSING : HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PIN : PHOSPHOR BRONZE.
- ④ FINISH
PIN
UNDER PLATING : 0.5µm MIN. Ni.
CONTACT AREA : 0.076 µm MIN. GOLD

SOLDER AREA(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER AREA(LEAD FREE OPTION): 2.5µm MIN. PURE TIN

⑤ SEQUENCE PIN ASSIGNMENT

	DIM "L"		
	4.25±0.1	3.5±0.1	5.0±0.1
PIN No.	OTHERS	36.67	35.51.68

- 6 GENERAL TOLERANCE : ±0.3
- 7 IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE
SOLDER TAIL : SMT-IL, SMT-STG CAN RESIST 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
SOLDER TAIL : R/A CAN RESIST 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- 8 IF LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
- 9 PRODUCT SPEC:110-263

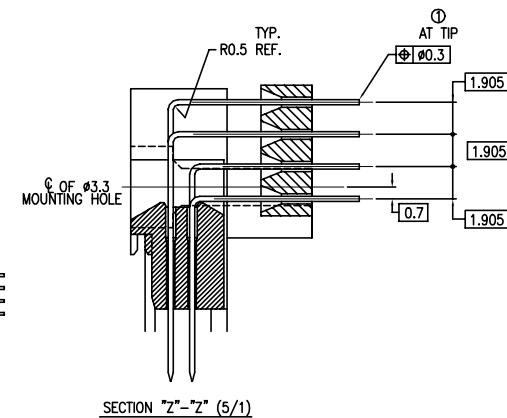
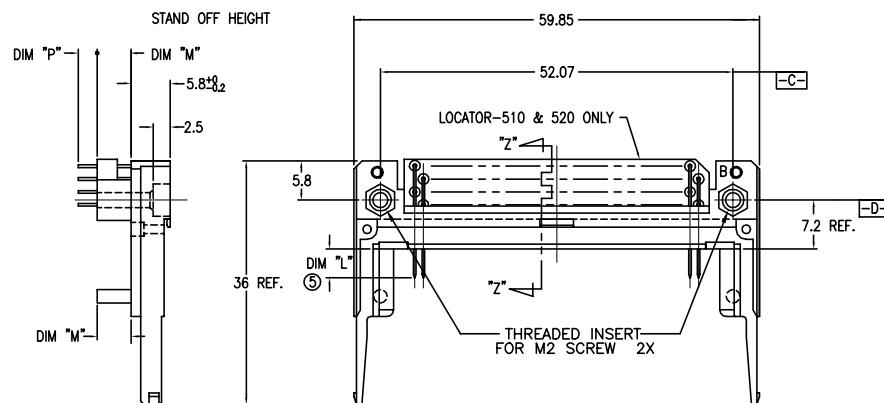
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ltnecn nodr date	tolerances unless otherwise specified	angle 0°±2'	scale 1:1	title 68 POS. EJECTOR HEADER ASSY. FOR LOW VOLTAGE
dr S.DUESTERHOEF	7/20/95	engr D.BRANN	7/20/95	dwg no 95706
chr D.BRANN	7/20/95	appd D.BRANN	7/20/95	sheet 3 of 5
type Product Customer Drawing				size A4
sheet index	revision sheet			

PRODUCT NO.

95706-510/510LF

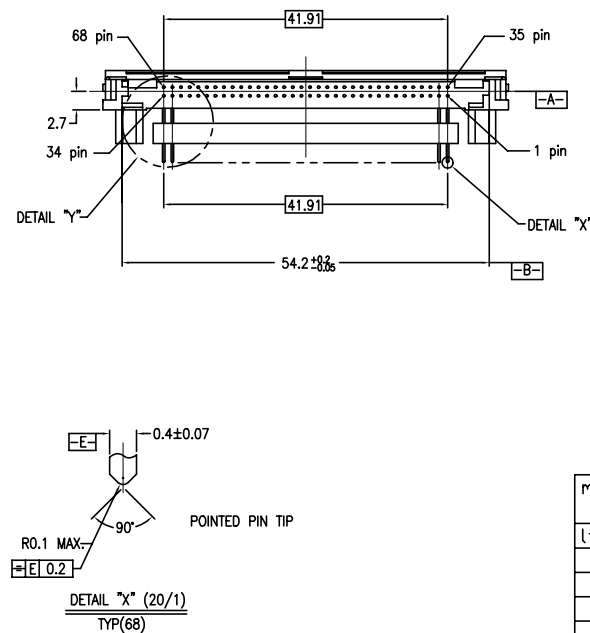
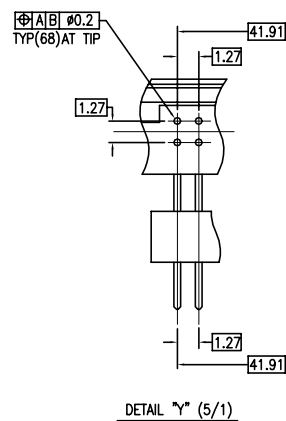
95706-520/520LF

95706-540/540LF



NOTES

- ① TRUE POSITION IS A FREE GRID TO PIN PATTERN ITSELF
 ② SEE TA-946 FOR PCB LAYOUT
 ③ MATERIAL
 HOUSING : HIGH TEMPERATURE THERMOPLASTIC UL94V-0 NATURAL
 PIN : PHOSPHOR BRONZE
 ④ FINISH
 PIN
 UNDER PLATING : 0.5µm MIN. Ni
 CONTACT AREA : 0.076 µm MIN. GOLD
 SOLDER AREA(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 SOLDER AREA(LEAD FREE OPTION): 2.5µm MIN. PURE TIN
 ⑤ SEQUENCE PIN ASSIGNMENT
- | PIN No. | DIM "I" (mm) | | |
|---------|--------------|---------|---------|
| | 4.25±0.1 | 3.5±0.1 | 5.0±0.1 |
| OTHERS | 36.67 | 1.17 | 35.51 |
- 6 GENERAL TOLERANCE : ±0.3
 7 IF LEAD FREE P/N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE
 SOLDER TAIL : SMT-IL, SMT-STG CAN RESIST 40 SECONDS IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
 SOLDER TAIL : R/A CAN RESIST 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
 8 IF LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
 9 PRODUCT SPEC:110-263



mat'l. code	surface ISO1302	tolerance ISO1101 ISO406	projection MM	product family MCS
ltn ecn nodr date	tolerances unless otherwise specified	angle 0°±2'	scale 1:1	title 68 POS. EJECTOR HEADER ASSY. FOR LOW VOLTAGE
D	engr D.BRANN	7/20/95	dwg no	sheet 5 of 5
	chr D.BRANN	7/20/95	95706	A4
	appd D.BRANN	7/20/95	type	Product Customer Drawing
sheet index	revision sheet			